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## HEF4066B

## Quad single-pole single-throw analog switch

Rev. 8 - 11 September 2014
Product data sheet

## 1. General description

The HEF4066B provides four single-pole, single-throw analog switch functions. Each switch has two input/output terminals ( nY and nZ ) and an active HIGH enable input ( nE ). When nE is LOW, the analog switch is turned off.

The HEF4066B is pin compatible with the HEF4016B but exhibits a much lower ON resistance. In addition the ON resistance is relatively constant over the full input signal range.

## 2. Features and benefits

- Fully static operation
- 5 V , 10 V , and 15 V parametric ratings

■ Standardized symmetrical output characteristics

- Inputs and outputs are protected against electrostatic effects
- Specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
- Complies with JEDEC standard JESD 13-B


## 3. Applications

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating


## 4. Ordering information

Table 1. Ordering information

| Type number | Package |  |  |  |
| :--- | :--- | :--- | :--- | :--- |
|  | Temperature range | Name | Description | Version |
| HEF4066BP | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | DIP14 | plastic dual in-line package; 14 leads (300 mil) | SOT27-1 |
| HEF4066BT | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | SO14 | plastic small outline package; 14 leads; <br> body width 3.9 mm | SOT108-1 |

## 5. Functional diagram



Fig 1. Functional diagram


Fig 2. Logic diagram (one switch)

## 6. Pinning information

### 6.1 Pinning



Fig 3. Pin configuration

### 6.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
| :--- | :--- | :--- |
| $1 \mathrm{Y}, 2 \mathrm{Y}, 3 \mathrm{Y}, 4 \mathrm{Y}$ | $1,4,8,11$ | independent input or output |
| $1 \mathrm{Z}, 2 \mathrm{Z}, 3 \mathrm{Z}, 4 \mathrm{Z}$ | $2,3,9,10$ | independent input or output |
| $1 \mathrm{E}, 2 \mathrm{E}, 3 \mathrm{E}, 4 \mathrm{E}$ | $13,5,6,12$ | enable input (active HIGH) |
| $\mathrm{V}_{\text {SS }}$ | 7 | ground (0 V) |
| $\mathrm{V}_{\mathrm{DD}}$ | 14 | supply voltage |

## 7. Functional description

Table 3. Function table[1]

| Input $\mathbf{n E}$ | Switch |
| :--- | :--- |
| $H$ | ON |
| L | OFF |

[1] $H=$ HIGH voltage level; $L=$ LOW voltage level.

## 8. Limiting values

Table 4. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to VSS $=0 \mathrm{~V}$ (ground).

| Symbol | Parameter | Conditions |  | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {DD }}$ | supply voltage |  |  | -0.5 | +18 | V |
| $\mathrm{I}_{\mathrm{IK}}$ | input clamping current | $\mathrm{V}_{1}<-0.5 \mathrm{~V}$ or $\mathrm{V}_{1}>\mathrm{V}_{\mathrm{DD}}+0.5 \mathrm{~V}$ |  | - | $\pm 10$ | mA |
| $\mathrm{V}_{1}$ | input voltage |  |  | -0.5 | $\mathrm{V}_{\mathrm{DD}}+0.5$ | V |
| $I_{\text {/ }}$ | input/output current |  | [1] | - | $\pm 10$ | mA |
| $\mathrm{T}_{\text {stg }}$ | storage temperature |  |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {amb }}$ | ambient temperature |  |  | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| $P_{\text {tot }}$ | total power dissipation | $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |  |
|  |  | DIP14 | [2] | - | 750 | mW |
|  |  | SO14 | [3] | - | 500 | mW |
| P | power dissipation | per switch |  | - | 100 | mW |

[1] To avoid drawing $V_{D D}$ current out of terminal $n Z$, when switch current flows into terminals $n Y$, the voltage drop across the bidirectional switch must not exceed 0.4 V . If the switch current flows into terminal $n Z$, no $\mathrm{V}_{\mathrm{DD}}$ current will flow out of terminals $\mathrm{n} Y$, in this case there is no limit for the voltage drop across the switch, but the voltages at $n Y$ and $n Z$ may not exceed $V_{D D}$ or $\mathrm{V}_{\mathrm{SS}}$.
[2] For DIP14 packages: above $T_{a m b}=70^{\circ} \mathrm{C}, \mathrm{P}_{\text {tot }}$ derates linearly with $12 \mathrm{~mW} / \mathrm{K}$.
[3] For SO14 packages: above $\mathrm{T}_{\mathrm{amb}}=70^{\circ} \mathrm{C}, \mathrm{P}_{\text {tot }}$ derates linearly with $8 \mathrm{~mW} / \mathrm{K}$.

## 9. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {D }}$ | supply voltage |  | 3 | - | 15 | V |
| $V_{1}$ | input voltage |  | 0 | - | $V_{D D}$ | V |
| $\mathrm{T}_{\text {amb }}$ | ambient temperature | in free air | -40 | - | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\Delta \mathrm{t} / \Delta \mathrm{V}$ | input transition rise and fall rate | $V_{D D}=5 \mathrm{~V}$ | - | - | 3.75 | $\mu \mathrm{s} / \mathrm{V}$ |
|  |  | $V_{D D}=10 \mathrm{~V}$ | - | - | 0.5 | $\mu \mathrm{s} / \mathrm{V}$ |
|  |  | $V_{D D}=15 \mathrm{~V}$ | - | - | 0.08 | $\mu \mathrm{s} / \mathrm{V}$ |

Quad single-pole single-throw analog switch

## 10. Static characteristics

Table 6. Static characteristics
$V_{S S}=0 V ; V_{I}=V_{S S}$ or $V_{D D}$ unless otherwise specified.

| Symbol | Parameter | Conditions | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ |  | $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$ |  | $\mathrm{T}_{\mathrm{amb}}=8{ }^{\circ} \mathrm{C}$ |  | $\mathrm{T}_{\mathrm{amb}}=125^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Max | Min | Max | Min | Max | Min | Max |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\mid \mathrm{l}_{\mathrm{O}} \mathrm{l}$ < $1 \mu \mathrm{~A}$ | 5 V | 3.5 | - | 3.5 | - | 3.5 | - | 3.5 | - | V |
|  |  |  | 10 V | 7.0 | - | 7.0 | - | 7.0 | - | 7.0 | - | V |
|  |  |  | 15 V | 11.0 | - | 11.0 | - | 11.0 | - | 11.0 | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage | \| $\mathrm{l}_{\mathrm{O}} \mathrm{l}$ < $1 \mu \mathrm{~A}$ | 5 V | - | 1.5 | - | 1.5 | - | 1.5 | - | 1.5 | V |
|  |  |  | 10 V | - | 3.0 | - | 3.0 | - | 3.0 | - | 3.0 | V |
|  |  |  | 15 V | - | 4.0 | - | 4.0 | - | 4.0 | - | 4.0 | V |
| I | input leakage current |  | 15 V | - | $\pm 0.1$ | - | $\pm 0.1$ | - | $\pm 1.0$ | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {S(OFF })}$ | OFF-state leakage current | per channel; see Figure 4 | 15 V | - | - | - | 200 | - | - | - | - | nA |
| IDD | supply current | all valid input combinations | 5 V | - | 1.0 | - | 1.0 | - | 7.5 | - | 7.5 | $\mu \mathrm{A}$ |
|  |  |  | 10 V | - | 2.0 | - | 2.0 | - | 15.0 | - | 15.0 | $\mu \mathrm{A}$ |
|  |  |  | 15 V | - | 4.0 | - | 4.0 | - | 30.0 | - | 30.0 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{1}$ | input capacitance | $n E$ input | - | - | - | - | 7.5 | - | - | - | - | pF |

### 10.1 Test circuit



Fig 4. Test circuit for measuring OFF-state leakage current

### 10.2 ON resistance

Table 7. ON resistance
$T_{\text {amb }}=25^{\circ} \mathrm{C} ; I_{S W}=200 \mu \mathrm{~A} ; V_{S S}=0 \mathrm{~V}$.

| Symbol | Parameter | Conditions | $\mathrm{V}_{\mathrm{DD}}$ | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{R}_{\text {ON( } \text { (peak) }}$ | ON resistance (peak) | $\mathrm{V}_{1}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}$; see Figure 5 and Figure 6 | 5 V | 350 | 2500 | $\Omega$ |
|  |  |  | 10 V | 80 | 245 | $\Omega$ |
|  |  |  | 15 V | 60 | 175 | $\Omega$ |
| RON(rail) | ON resistance (rail) | $\mathrm{V}_{\mathrm{I}}=0 \mathrm{~V}$; see Figure 5 and Figure 6 | 5 V | 115 | 340 | $\Omega$ |
|  |  |  | 10 V | 50 | 160 | $\Omega$ |
|  |  |  | 15 V | 40 | 115 | $\Omega$ |
|  |  | $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{DD}}$; see Figure 5 and Figure 6 | 5 V | 120 | 365 | $\Omega$ |
|  |  |  | 10 V | 65 | 200 | $\Omega$ |
|  |  |  | 15 V | 50 | 155 | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON }}$ | ON resistance mismatch between channels | $\mathrm{V}_{1}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{D}}$; see Figure 5 | 5 V | 25 | - | $\Omega$ |
|  |  |  | 10 V | 10 | - | $\Omega$ |
|  |  |  | 15 V | 5 | - | $\Omega$ |

10.2.1 ON resistance waveform and test circuit

$\mathrm{R}_{\mathrm{ON}}=\mathrm{V}_{\mathrm{SW}} / \mathrm{I}_{\mathrm{SW}}$.

Fig 5. Test circuit for measuring $\mathrm{R}_{\mathrm{ON}}$


Fig 6. Typical $R_{\text {ON }}$ as a function of input voltage

## 11. Dynamic characteristics

Table 8. Dynamic characteristics
$T_{a m b}=25^{\circ} \mathrm{C}$; $V_{S S}=0 \mathrm{~V}$; for test circuit see Figure 9.

| Symbol | Parameter | Conditions | $\mathrm{V}_{\mathrm{DD}}$ | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {PHL }}$ | HIGH to LOW propagation delay | $n \mathrm{Y}, \mathrm{nZ}$ to nZ, nY; see Figure 7 | 5 V | 10 | 20 | ns |
|  |  |  | 10 V | 5 | 10 | ns |
|  |  |  | 15 V | 5 | 10 | ns |
|  |  | $n \mathrm{Y}, \mathrm{nZ}$ to nZ, nY; see Figure 7 | 5 V | 10 | 20 | ns |
|  |  |  | 10 V | 5 | 10 | ns |
|  |  |  | 15 V | 5 | 10 | ns |
| $\mathrm{t}_{\text {PHZ }}$ | HIGH to OFF-state propagation delay | nE to $\mathrm{nY}, \mathrm{nZ}$; see Figure 8 | 5 V | 80 | 160 | ns |
|  |  |  | 10 V | 65 | 130 | ns |
|  |  |  | 15 V | 60 | 120 | ns |
| $t_{\text {PZ }}$ | OFF-state to HIGH propagation delay | nE to $\mathrm{nY}, \mathrm{nZ}$; see Figure 8 | 5 V | 40 | 80 | ns |
|  |  |  | 10 V | 20 | 40 | ns |
|  |  |  | 15 V | 15 | 30 | ns |
| tpLz | LOW to OFF-state propagation delay | $n \mathrm{n}$ to $\mathrm{nY}, \mathrm{nZ}$; see Figure 8 | 5 V | 80 | 160 | ns |
|  |  |  | 10 V | 70 | 140 | ns |
|  |  |  | 15 V | 70 | 140 | ns |
| $t_{\text {PZL }}$ | OFF-state to LOW propagation delay | nE to $\mathrm{nY}, \mathrm{nZ}$; see Figure 8 | 5 V | 45 | 90 | ns |
|  |  |  | 10 V | 20 | 40 | ns |
|  |  |  | 15 V | 15 | 30 | ns |

Table 9. Dynamic power dissipation $\mathrm{P}_{\mathrm{D}}$
$P_{D}$ can be calculated from the formulas shown; $V_{S S}=0 \mathrm{~V} ; t_{r}=t_{f} \leq 20 \mathrm{~ns} ; T_{a m b}=25^{\circ} \mathrm{C}$.

| Symbol | Parameter | VDD | Typical formula for $\mathrm{P}_{\mathrm{D}}(\mu \mathrm{W})$ | where: |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{P}_{\mathrm{D}}$ | dynamic power dissipation | 5 V | $\mathrm{P}_{\mathrm{D}}=2500 \times \mathrm{f}_{\mathrm{i}}+\Sigma\left(\mathrm{f}_{\mathrm{o}} \times \mathrm{C}_{\mathrm{L}}\right) \times \mathrm{V}_{\text {DD }}{ }^{2}$ | $\begin{aligned} & \mathrm{f}_{\mathrm{i}}=\text { input frequency in } \mathrm{MHz} ; \\ & \mathrm{f}_{\mathrm{O}}=\text { output frequency in } \mathrm{MHz} ; \\ & \mathrm{C}_{\mathrm{L}}=\text { output load capacitance in } \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{DD}}=\text { supply voltage in } \mathrm{V} ; \\ & \Sigma\left(\mathrm{C}_{\mathrm{L}} \times \mathrm{f}_{\mathrm{o}}\right)=\text { sum of the outputs. } \end{aligned}$ |
|  |  | 10 V | $\mathrm{P}_{\mathrm{D}}=11500 \times \mathrm{f}_{\mathrm{i}}+\Sigma\left(\mathrm{f}_{0} \times \mathrm{C}_{\mathrm{L}}\right) \times \mathrm{V}_{\text {DD }}{ }^{2}$ |  |
|  |  | 15 V | $\mathrm{P}_{\mathrm{D}}=29000 \times \mathrm{f}_{\mathrm{i}}+\Sigma\left(\mathrm{f}_{0} \times \mathrm{C}_{\mathrm{L}}\right) \times \mathrm{V}_{\text {DD }}{ }^{2}$ |  |

### 11.1 Waveforms and test circuit



Measurement points are given in Table 10.
Fig 7. $\quad n Y$ or $n Z$ to $n Z$ or $n Y$ propagation delays


Measurement points are given in Table 10.
Fig 8. Enable and disable times

Table 10. Measurement points

| Supply voltage | Input | Output |
| :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{DD}}$ | $\mathbf{V}_{\mathbf{M}}$ | $\mathbf{V}_{\mathbf{M}}$ |
| 5 V to 15 V | $0.5 \mathrm{~V}_{\mathrm{DD}}$ | $0.5 \mathrm{~V}_{\mathrm{DD}}$ |



Test data is given in Table 11.
Definitions:
DUT = Device Under Test.
$R_{T}=$ Termination resistance should be equal to output impedance $Z_{0}$ of the pulse generator.
$\mathrm{C}_{\mathrm{L}}=$ Load capacitance including test jig and probe.
$R_{L}=$ Load resistance.
Fig 9. Test circuit for measuring switching times

Table 11. Test data

| Supply voltage | Input |  | Load |  | S1 position |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {DD }}$ | $V_{1}$ | $\mathbf{t r}_{\mathrm{r}}, \mathbf{t}_{\mathrm{f}}$ | $\mathrm{C}_{\mathrm{L}}$ | $\mathbf{R}_{\mathrm{L}}$ | $\mathrm{t}_{\text {PHL }}, \mathrm{t}_{\text {PLH }}$ | $\mathrm{t}_{\text {PZH }}, \mathrm{t}_{\text {PHZ }}$ | $\mathrm{t}_{\text {PZL }}, \mathrm{t}_{\text {PLZ }}$ |
| 5 V to 15 V | 0 V or $\mathrm{V}_{\mathrm{DD}}$ | $\leq 20 \mathrm{~ns}$ | 50 pF | $10 \mathrm{k} \Omega$ | $\mathrm{V}_{\text {SS }}$ | $\mathrm{V}_{S S}$ | $\mathrm{V}_{\mathrm{DD}}$ |

### 11.2 Additional dynamic parameters

Table 12. Additional dynamic characteristics
$V_{S S}=0 V ; T_{a m b}=25^{\circ} \mathrm{C}$.

| Symbol | Parameter | Conditions | $V_{\text {DD }}$ |  | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| THD | total harmonic distortion | see Figure 10; $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega ; \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$; channel $O N ; V_{1}=0.5 V_{D D}(p-p)$;$\mathrm{f}_{\mathrm{i}}=1 \mathrm{kHz}$ | 5 V | [1] | 0.25 | - | \% |
|  |  |  | 10 V | [1] | 0.04 | - | \% |
|  |  |  | 15 V | [1] | 0.04 | - | \% |
| $\mathrm{V}_{\mathrm{ct}}$ | crosstalk voltage | nE input to switch; see Figure 11; $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega ; \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} ;$ <br> $\mathrm{nE}=\mathrm{V}_{\mathrm{DD}}$ (square-wave) | 10 V |  | 50 | - | mV |

Table 12. Additional dynamic characteristics ...continued
$V_{S S}=0 \mathrm{~V} ; T_{\text {amb }}=25^{\circ} \mathrm{C}$.

| Symbol | Parameter | Conditions | $\mathrm{V}_{\text {D }}$ |  | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Xtalk | crosstalk | between switches; see Figure 12; $\begin{aligned} & \mathrm{f}_{\mathrm{i}}=1 \mathrm{MHz} ; \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega ; \\ & \mathrm{V}_{\mathrm{I}}=0.5 \mathrm{~V}_{\mathrm{DD}}(\mathrm{p}-\mathrm{p}) \end{aligned}$ | 10 V | [1] | -50 | - | dB |
| $\alpha_{\text {iso }}$ | isolation (OFF-state) | $\begin{aligned} & \text { see Figure } 13 ; f_{i}=1 \mathrm{MHz} ; \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \\ & \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF} ; \mathrm{V}_{\mathrm{I}}=0.5 \mathrm{~V}_{\mathrm{DD}}(\mathrm{p}-\mathrm{p}) \end{aligned}$ | 10 V | [1] | -50 | - | dB |
| $\mathrm{f}_{(-3 \mathrm{~dB})}$ | -3 dB frequency response | $\begin{aligned} & \text { see Figure } 14 ; \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega ; \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{I}}=0.5 \mathrm{~V}_{\mathrm{DD}}(\mathrm{p}-\mathrm{p}) \end{aligned}$ | 10 V | [1] | 90 | - | MHz |

[1] $f_{i}$ is biased at $0.5 \mathrm{~V}_{\mathrm{DD}}$.

### 11.2.1 Test circuits



Fig 10. Test circuit for measuring total harmonic distortion

a. Test circuit

b. Input and output pulse definitions

Fig 11. Test circuit for measuring crosstalk voltage between digital input and switch

$20 \log _{10}\left(\mathrm{~V}_{\mathrm{O} 2} / \mathrm{V}_{\mathrm{O} 1}\right)$ or $20 \log _{10}\left(\mathrm{~V}_{\mathrm{O} 1} / \mathrm{V}_{\mathrm{O} 2}\right)$.
Fig 12. Test circuit for measuring crosstalk between switches


Adjust $f_{i}$ voltage to obtain 0 dBm level at input.

Fig 13. Test circuit for measuring isolation (OFF-state)


Adjust $f_{i}$ voltage to obtain 0 dBm level at output. Increase $\mathrm{f}_{\mathrm{i}}$ frequency until dB meter reads -3 dB .

Fig 14. Test circuit for measuring frequency response

## 12. Package outline



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | $A_{1}$ min. | $A_{2}$ max. | b | $\mathrm{b}_{1}$ | C | $D^{(1)}$ | $E^{(1)}$ | e | $\mathbf{e l}_{1}$ | L | $\mathrm{M}_{\mathrm{E}}$ | $\mathrm{M}_{\mathrm{H}}$ | w | $\mathrm{Z}^{(1)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 4.2 | 0.51 | 3.2 | $\begin{aligned} & 1.73 \\ & 1.13 \end{aligned}$ | $\begin{aligned} & 0.53 \\ & 0.38 \end{aligned}$ | $\begin{aligned} & 0.36 \\ & 0.23 \end{aligned}$ | $\begin{aligned} & 19.50 \\ & 18.55 \end{aligned}$ | $\begin{aligned} & 6.48 \\ & 6.20 \end{aligned}$ | 2.54 | 7.62 | $\begin{aligned} & 3.60 \\ & 3.05 \end{aligned}$ | $\begin{aligned} & 8.25 \\ & 7.80 \end{aligned}$ | $\begin{gathered} 10.0 \\ 8.3 \end{gathered}$ | 0.254 | 2.2 |
| inches | 0.17 | 0.02 | 0.13 | $\begin{aligned} & 0.068 \\ & 0.044 \end{aligned}$ | $\begin{aligned} & 0.021 \\ & 0.015 \end{aligned}$ | $\begin{aligned} & 0.014 \\ & 0.009 \end{aligned}$ | $\begin{aligned} & 0.77 \\ & 0.73 \end{aligned}$ | $\begin{aligned} & 0.26 \\ & 0.24 \end{aligned}$ | 0.1 | 0.3 | $\begin{aligned} & 0.14 \\ & 0.12 \end{aligned}$ | $\begin{aligned} & 0.32 \\ & 0.31 \end{aligned}$ | $\begin{aligned} & 0.39 \\ & 0.33 \end{aligned}$ | 0.01 | 0.087 |

Note

1. Plastic or metal protrusions of 0.25 mm ( 0.01 inch ) maximum per side are not included.

| OUTLINE VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |
| SOT27-1 | 050G04 | MO-001 | SC-501-14 | $\square$ ¢ | $\begin{aligned} & -99-12-27 \\ & 03-02-13 \end{aligned}$ |

Fig 15. Package outline SOT27-1 (DIP14)

Quad single-pole single-throw analog switch


DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | $\begin{gathered} \mathrm{A} \\ \max . \end{gathered}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $D^{(1)}$ | $E^{(1)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $\mathrm{L}_{\mathrm{p}}$ | Q | v | w | y | $Z^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 1.75 | $\begin{aligned} & 0.25 \\ & 0.10 \end{aligned}$ | $\begin{aligned} & 1.45 \\ & 1.25 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.49 \\ & 0.36 \end{aligned}$ | $\begin{aligned} & 0.25 \\ & 0.19 \end{aligned}$ | $\begin{aligned} & \hline 8.75 \\ & 8.55 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 3.8 \end{aligned}$ | 1.27 | $\begin{aligned} & \hline 6.2 \\ & 5.8 \end{aligned}$ | 1.05 | $\begin{aligned} & 1.0 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 0.7 \\ & 0.6 \end{aligned}$ | 0.25 | 0.25 | 0.1 | $\begin{aligned} & 0.7 \\ & 0.3 \end{aligned}$ | $8^{\circ}$ |
| inches | 0.069 | $\begin{aligned} & 0.010 \\ & 0.004 \end{aligned}$ | $\begin{aligned} & 0.057 \\ & 0.049 \end{aligned}$ | 0.01 | $\begin{aligned} & 0.019 \\ & 0.014 \end{aligned}$ | $\begin{array}{\|l\|} \hline 0.0100 \\ 0.0075 \end{array}$ | $\begin{aligned} & 0.35 \\ & 0.34 \end{aligned}$ | $\begin{aligned} & 0.16 \\ & 0.15 \end{aligned}$ | 0.05 | $\begin{aligned} & 0.244 \\ & 0.228 \end{aligned}$ | 0.041 | $\begin{aligned} & 0.039 \\ & 0.016 \end{aligned}$ | $\begin{aligned} & 0.028 \\ & 0.024 \end{aligned}$ | 0.01 | 0.01 | 0.004 | $\begin{aligned} & 0.028 \\ & 0.012 \end{aligned}$ | $0^{\circ}$ |

Note

1. Plastic or metal protrusions of 0.15 mm ( 0.006 inch) maximum per side are not included.

| OUTLINE VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |
| SOT108-1 | 076E06 | MS-012 |  | $\square \oplus$ | $\begin{aligned} & \hline 99-12-27 \\ & 03-02-19 \end{aligned}$ |

Fig 16. Package outline SOT108-1 (SO14)

## 13. Abbreviations

Table 13. Abbreviations

| Acronym | Description |
| :--- | :--- |
| DUT | Device Under Test |

## 14. Revision history

Table 14. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| :---: | :---: | :---: | :---: | :---: |
| HEF4066B v. 8 | 20140911 | Product data sheet | - | HEF4066B v. 7 |
| Modifications: | - Figure 11: Test circuit modified |  |  |  |
| HEF4066B v. 7 | 20111116 | Product data sheet | - | HEF4066B v. 6 |
| Modifications: | - Legal pages updated. <br> - Changes in "General description", "Features and benefits" and "Applications". |  |  |  |
| HEF4066B v. 6 | 20100325 | Product data sheet | - | HEF4066B v. 5 |
| HEF4066B v. 5 | 20100225 | Product data sheet | - | HEF4066B v. 4 |
| HEF4066B v. 4 | 20091013 | Product data sheet | - | HEF4066B_CNV v. 3 |
| HEF4066B_CNV v. 3 | 19950101 | Product specification | - | HEF4066B_CNV v. 2 |
| HEF4066B_CNV v. 2 | 19950101 | Product specification | - | - |

## 15. Legal information

### 15.1 Data sheet status

| Document status $[1][2]$ | Product status $[3]$ | Definition |
| :--- | :--- | :--- |
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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## Quad single-pole single-throw analog switch

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